

Declaration and Power of Attorney United States Patent Application UNITED STATES
Patents and Design Patents
Sole & Joint Inventors
Convention & Non-convention
PCT & Non-PCT
This form cannot be amended, altered
or changed after it is signed.
(For use only for inventors who
understand the English language.)

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below, next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below), or an original, first and joint inventor (if plural names are listed below), of the subject matter which is claimed and for which a patent is sought on the invention entitled:

## RESIN COMPOSITION FOR ENCAPSULATING SEMICONDUCTOR CHIP AND SEMICONDUCTOR DEVICE THEREWITH

the specification of which: (check or		<u>n</u>			
□ is attached hereto					
□ was filed as Attorney Do	on				
was filed as U.S. Application No. 10/809,182			on <u>N</u>	March 25, 2004	
and (if applicable) was an	nended on				
□ was filed as PCT Applica	ation No	·	on		
and (if applicable) was an	nended under PCT Arti	icle 19 on			
I have reviewed and understand the coamendment referred to above.	ontents of the above-id	entified specifica	ation, including	g the claims, as amended by any	
I acknowledge the duty to disclose inf Regulations, §1.56.	formation which is mat	terial to patentab	ility as defined	l in Title 37, Code of Federal	
I hereby claim foreign priority benefit application(s) for patent or inventor's one country other than the United Star application for patent or inventor's cer application(s) on which priority is cla	certificate, or §365(a) etes of America listed in tificate or PCT internations.	of any PCT inter n this Declaration	national application in a second contraction in a seco	cation which designated at least identified below any foreign	
Foreign/PCT Application No.	Country	Filing	Date	Priority Claimed - Yes/No	
2003-083937	Japan	25 March 2003		Yes	
2003-083938	Japan	25 March 2003		Yes	
I hereby claim the benefit under Title international application designating to feach of the claims of this application application in the manner provided by disclose information which is materia became available between the filing dapplication:	the United States of Ar on is not disclosed in the the first paragraph of I to patentability as def	nerica listed in the prior United S Title 35, United fined in Title 37,	his Declaration tates application States Code, § Code of Fede	n and, insofar as the subject matter on or PCT international §112, I acknowledge the duty to ral Regulations, §1.56 which	
U.S. Application No.	Filing Date		Status - Patented/Pending/Abandoned		
			_		
I hereby claim priority benefits under below:	Title 35 United States	Code §119(e) of	f any U.S. prov	visional application(s) listed	
U.S. Provisional Application No.			Filing Date		



I hereby appoint the following attorneys to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith: Robert G. Weilacher (20,531), Herbert M. Hanegan (25,682), Dale Lischer (28,438), Frederick F. Calvetti (28,557), J. Rogers Lunsford, III (29,405), Michael A. Makuch (32,263), Dennis C. Rodgers (32,936), Mary A. Montebello (33,021), Eric J. Hanson (44,738), Brandon S. Boss (46,567), Brett L. Nelson (48,119), Robert J. Veal (30,895), Christopher A. Holland (46,316) and Brendan E. Squire (48,749).

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon

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Citzenship	:		
Residence (city, state, country)	:		
Post office address	<b>:</b>		
Signature :	Date :		